

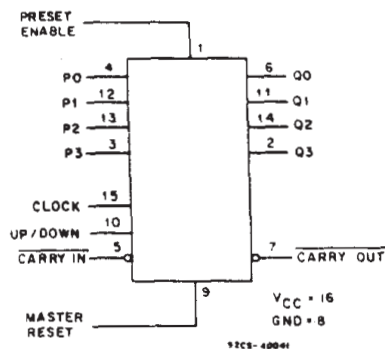


Data sheet acquired from Harris Semiconductor
SCHS302

August 2000

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

High-Speed CMOS Logic



FUNCTIONAL DIAGRAM

Presetable Synchronous 4-Bit Up/Down Counters

CD54/74HC/HCT4510 BCD Decade Counter,
Asynchronous Reset
CD54/74HC/HCT4516 4-Bit Binary Counter,
Asynchronous Reset

Type Features:

- Synchronous counting and asynchronous loading
- Look-ahead carry for high-speed counting

The CD54/74HC/HCT4510 presetable BCD up/down counter and the CD54/74HC/HCT4516 presetable binary up/down counter consist of four synchronously clocked D-type flip-flops (with a gating structure to provide T-type flip-flop capability) connected as counters. These counters can be cleared by a high level on the Master Reset line, and can be preset to any binary number present on the preset inputs by a high level on the Preset Enable line. The 4510 will count out of non-BCD counter states in a maximum of two clock pulses in the up mode, and a maximum of four clock pulses in the down mode.

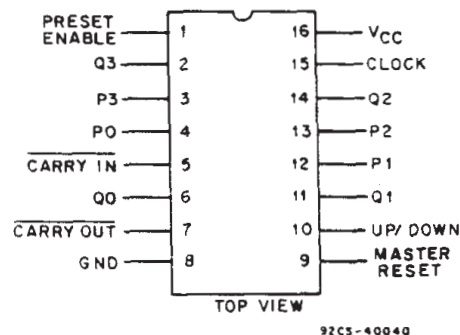
If the Carry-In input is held low, the counter advances up or down on each positive-going clock transition. Synchronous cascading is accomplished by connecting all clock inputs in parallel and connecting the Carry-Out of a less significant stage to the Carry-In of a more significant stage.

The 4510 and 4516 can be cascaded in the ripple mode by connecting the Carry-Out to the clock of the next stage. If the Up/Down input changes during a terminal count, the Carry-Out must be gated with the clock, and the Up/Down input must change while the clock is high. This method provides a clean clock signal to the subsequent counting stage. (See Fig. 5.)

The CD54HC/HCT4510 and the CD54HC/HCT4516 are supplied in 16-lead ceramic dual-in-line frit-seal packages (F suffix). The CD74HC/HCT4510 and the CD74HC/HCT4516 are supplied in 16-lead dual-in-line plastic packages (E suffix) and in 16-lead dual-in-line surface-mount plastic packages (M suffix). Both types are also available in chip form (H suffix).

Family Features:

- Fanout (over temperature range):
Standard outputs - 10 LSTTL loads
Bus driver outputs - 15 LSTTL loads
- Wide operating temperature range:
CD74HC/HCT: -40 to $+85^{\circ}\text{C}$
- Balanced propagation delay and transition times
- Significant power reduction compared to LSTTL logic ICs
- CD54HC/CD74HC types:
2 to 6 V operation
High noise immunity:
 $N_{IL}=30\%$, $N_{IH}=30\%$ of V_{CC} ; @ $V_{CC}=5\text{ V}$
- CD54HCT/CD74HCT types:
4.5 to 5.5 V operation
Direct LSTTL input logic compatibility
 $V_{IL}=0.8\text{ V max.}$, $V_{IH}=2\text{ V min.}$
CMOS input compatibility
 $I_L \leq 1\text{ }\mu\text{A}$ @ V_{OL} , V_{OH}



TERMINAL ASSIGNMENT

CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper IC Handling Procedures.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

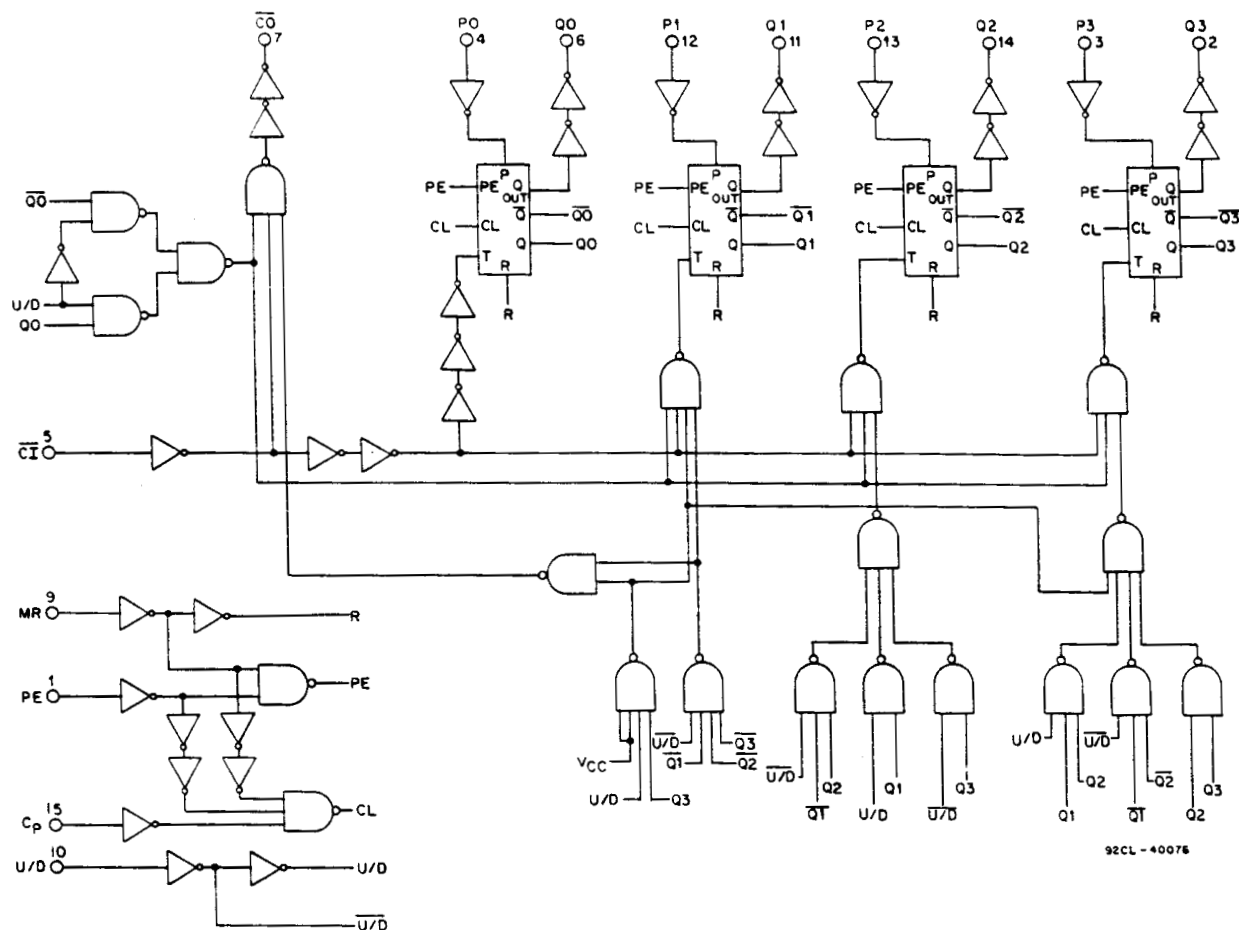


Fig. 1 - Logic diagram for HC/HCT4510.

TRUTH TABLE

CL	$\overline{\text{CI}}$	U/D	PE	MR	ACTION
X	H	X	L	L	NO COUNT
$\nearrow$	L	H	L	L	COUNT UP
$\searrow$	L	L	L	L	COUNT DOWN
X	X	X	H	L	PRESET
X	X	X	X	H	RESET

X = Don't Care H = High Voltage Level
L = Low Voltage Level

CD54/74HC4510, CD54/74HCT4510 **CD54/74HC4516, CD54/74HCT4516**

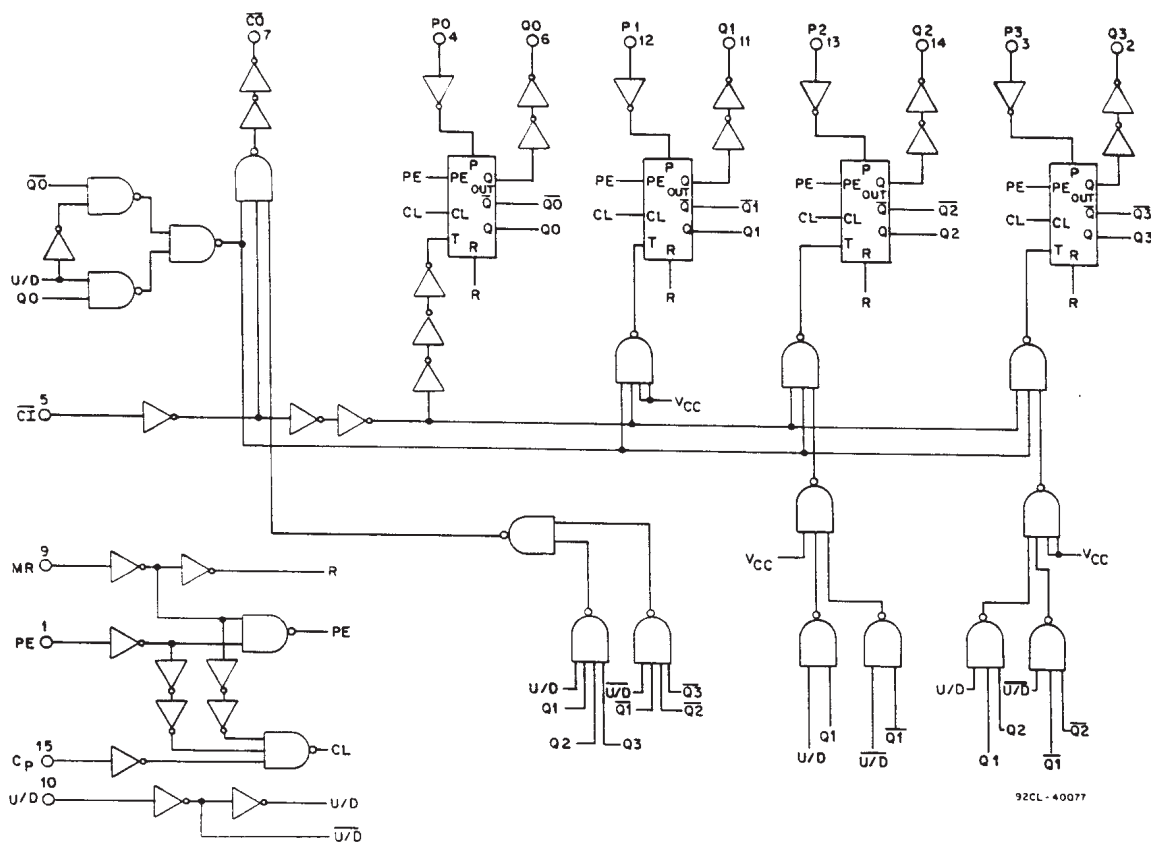


Fig. 2 - Logic diagram for HC/HCT4516.

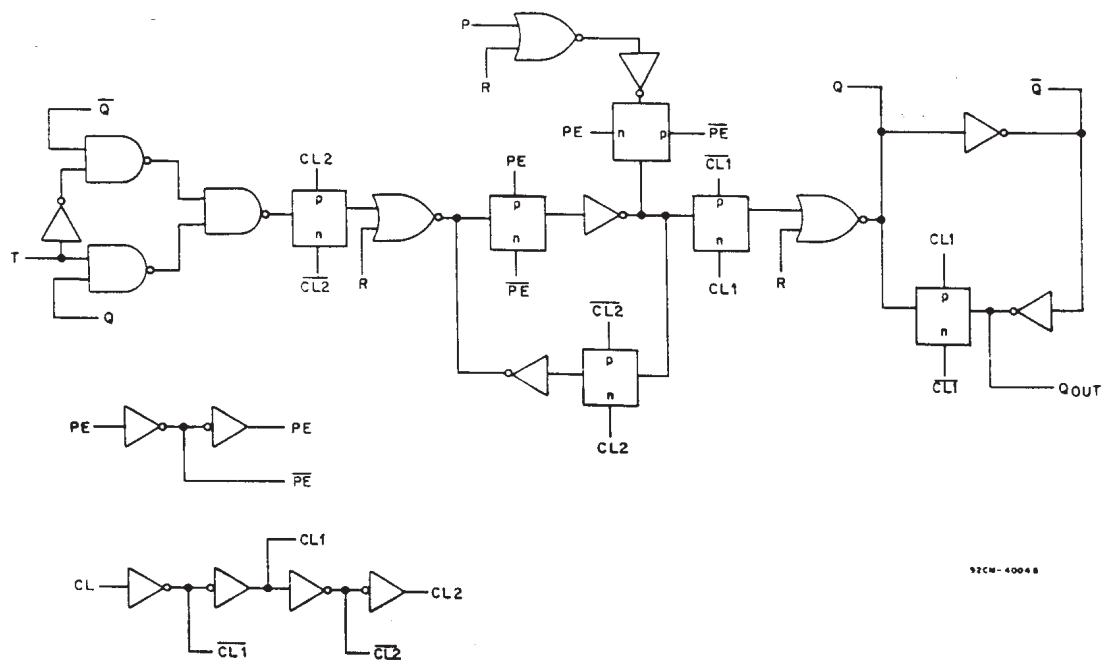


Fig. 3 - Logic diagram of flip-flops for HC/HCT4510/4516.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE, (V_{CC}):

(Voltages referenced to ground) -0.5 to +7 V

DC INPUT DIODE CURRENT, I_{IK} (FOR $V_i < -0.5$ V OR $V_i > V_{CC} + 0.5$ V) ± 20 mA

DC OUTPUT DIODE CURRENT, I_{OK} (FOR $V_o < -0.5$ V OR $V_o > V_{CC} + 0.5$ V) ± 20 mA

DC DRAIN CURRENT, PER OUTPUT (I_o) (FOR -0.5 V $< V_o < V_{CC} + 0.5$ V) ± 25 mA

DC V_{CC} OR GROUND CURRENT (I_{CC}) ± 50 mA

POWER DISSIPATION PER PACKAGE (P_D):

For $T_A = -40$ to $+60^\circ\text{C}$ (PACKAGE TYPE E) 500 mW

For $T_A = +60$ to $+85^\circ\text{C}$ (PACKAGE TYPE E) Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW

For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE F,H) 500 mW

For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE F,H) Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW

For $T_A = -40$ to $+70^\circ\text{C}$ (PACKAGE TYPE M) 400 mW

For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M) Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW

OPERATING-TEMPERATURE RANGE (T_A):

PACKAGE TYPE F,H -55 to $+125^\circ\text{C}$

PACKAGE TYPE E,M -40 to $+85^\circ\text{C}$

STORAGE TEMPERATURE (T_{STG}) -65 to $+150^\circ\text{C}$

LEAD TEMPERATURE (DURING SOLDERING):

At distance $1/16 \pm 1/32$ in. (1.59 ± 0.79 mm) from case for 10 s max. $+265^\circ\text{C}$

Unit inserted into a PC Board (min. thickness $1/16$ in., 1.59 mm)

with solder contacting lead tips only $+300^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range (For T_A =Full Package Temperature Range) V_{CC} .*			
CD54/74HC Types	2	6	V
CD54/74HCT Types	4.5	5.5	
DC Input or Output Voltage, V_i , V_o	0	V_{CC}	V
Operating Temperature, T_A :			
CD74 Types	-40	$+85$	$^\circ\text{C}$
CD54 Types	-55	$+125$	
Input Rise and Fall Times, t_r , t_f :			
at 2 V	0	1000	ns
at 4.5 V	0	500	
at 6 V	0	400	

*Unless otherwise specified, all voltages are referenced to Ground.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CD74HC4510/4516/CD54HC4510/4516										CD74HCT4510/4516/CD54HCT4510/4516										UNITS		
	TEST CONDITIONS			74HC/54HC TYPES			74HC TYPES		54HC TYPES		TEST CONDITIONS			74HCT/54HCT TYPES			74HCT TYPES		54HCT TYPES				
	V _I V	I _O mA	V _{CC} V	+25°C			-40/ +85°C		-55/ +125°C		V _I V	V _{CC} V	+25°C			-40/ +85°C		-55/ +125°C					
				Min	Typ	Max	Min	Max	Min	Max			Min	Typ	Max	Min	Max	Min	Max				
High-Level Input Voltage V _{IH}				2	1.5	—	—	1.5	—	1.5	—	—	4.5	2	—	—	2	—	2	—	V		
				4.5	3.15	—	—	3.15	—	3.15	—	—	to	—	—	0.8	—	0.8	—	0.8	V		
				6	4.2	—	—	4.2	—	4.2	—	—	5.5	—	—	—	—	—	—	—	V		
Low-Level Input Voltage V _{IL}				2	—	—	0.5	—	0.5	—	0.5	—	4.5	—	—	0.8	—	0.8	—	0.8	V		
				4.5	—	—	1.35	—	1.35	—	1.35	—	to	—	—	—	—	—	—	—	V		
				6	—	—	1.8	—	1.8	—	1.8	—	5.5	—	—	—	—	—	—	—	V		
High-Level Output Voltage V _{OH}	V _{IL}	-0.02		2	1.9	—	—	1.9	—	1.9	—	V _{IL}		4.5	4.4	—	—	4.4	—	4.4	—	V	
CMOS Loads	or V _{IH}			4.5	4.4	—	—	4.4	—	4.4	—	or V _{IH}		4.5	4.4	—	—	4.4	—	4.4	—	V	
				6	5.9	—	—	5.9	—	5.9	—											V	
TTL Loads	V _{IL}											V _{IL}		4.5	3.98	—	—	3.84	—	3.7	—	V	
	or V _{IH}			-4	4.5	3.98	—	—	3.84	—	3.7	—	or V _{IH}		4.5	3.98	—	—	3.84	—	3.7	—	V
				-5.2	6	5.48	—	—	5.34	—	5.2	—										V	
Low-Level Output Voltage V _{OL}	V _{IL}	0.02		2	—	—	0.1	—	0.1	—	0.1	V _{IL}		4.5	—	—	0.1	—	0.1	—	0.1	V	
CMOS Loads	or V _{IH}			4.5	—	—	0.1	—	0.1	—	0.1	or V _{IH}		4.5	—	—	0.1	—	0.1	—	0.1	V	
				6	—	—	0.1	—	0.1	—	0.1											V	
TTL Loads	V _{IL}											V _{IL}		4.5	—	—	0.26	—	0.33	—	0.4	V	
	or V _{IH}			4	4.5	—	—	0.26	—	0.33	—	or V _{IH}		4.5	—	—	0.26	—	0.33	—	0.4	V	
				5.2	6	—	—	0.26	—	0.33	—											V	
Input Leakage Current I _I	V _{CC} or Gnd		6	—	—	±0.1	—	±1	—	±1	Any Voltage Between V _{CC} & Gnd	5.5	—	—	±0.1	—	±1	—	±1	—	±1	μA	
Quiescent Device Current I _{CC}	V _{CC} or Gnd	0	6	—	—	8	—	80	—	160	V _{CC} or Gnd	5.5	—	—	8	—	80	—	160	—	160	μA	
Additional Quiescent Device Current per input pin: 1 unit load ΔI _{CC} *											V _{CC} -2.1	4.5 to 5.5	—	100	360	—	450	—	490	—	490	μA	

*For dual-supply systems theoretical worst case ($V_i = 2.4$ V, $V_{cc} = 5.5$ V) specification is 1.8 mA.

HCT Input Loading Table

Input	Unit Loads*
P0-P3	0.75
MR	1.5
U/D, PE, $\overline{CI}$	1
CP	1.25

*Unit Load is ΔI_{cc} limit specified in Static Characteristics Chart, e.g., 360 μA max. @ 25°C.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

SWITCHING CHARACTERISTICS ($V_{CC}=5\text{ V}$, $T_A=25^\circ\text{C}$, Input $t_r, t_f=6\text{ ns}$)

CHARACTERISTIC	C _L (pF)	TYPICAL VALUES				UNITS	
		4510		4516			
		HC	HCT	HC	HCT		
Propagation Delay:						ns	
CP to Q _n	t _{PLH} , t _{PHL}	15	18	21	18		21
CP to $\overline{CO}$	t _{PLH} , t _{PHL}	15	22	24	22		24
PE to Q _n	t _{PLH} , t _{PHL}	15	21	22	21		22
PE to $\overline{CO}$	t _{PLH} , t _{PHL}	15	25	28	25		28
MR to Q _n	t _{PHL}	15	18	18	18		18
MR to $\overline{CO}$	t _{PLH}	15	20	20	20		20
$\overline{CI}$ to $\overline{CO}$	t _{PLH} , t _{PHL}	15	10	13	10	13	
Power Dissipation Capacitance	C _{PD} *		59	65	68	72	pF

* C_{PD} is used to determine the dynamic power consumption, per package.

$P_D = C_{PD} V_{CC}^2 f_i + \Sigma (C_L V_{CC}^2 f_o)$ where f_i = input frequency

f_o = output frequency

C_L = output load capacitance

V_{CC} = supply voltage.

PRE-REQUISITE FOR SWITCHING FUNCTION

CHARACTERISTIC	TEST CONDITIONS V_{CC} (V)	LIMITS												UNITS	
		25° C				-40° C to +85° C				-55° C to +125° C					
		HC		HCT		74HC		74HCT		54HC		54HCT			
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
Pulse Width: CP	t_W	2 4.5 6	80 16 14	— — —	— 16 —	— — —	100 20 17	— — —	— 20 —	— — —	120 24 20	— — —	— 24 —	ns	
MR	t_W	2 4.5 6	100 20 17	— — —	— 20 —	— — —	125 25 21	— — —	— 25 —	— — —	150 30 26	— — —	— 30 —		
PE	t_W	2 4.5 6	80 16 14	— — —	— 16 —	— — —	100 20 17	— — —	— 20 —	— — —	120 24 20	— — —	— 24 —		
Setup Time, Pn to PE, $\overline{CI}$ to CP	t_{SU}	2 4.5 6	100 20 17	— — —	— 20 —	— — —	125 25 21	— — —	— 25 —	— — —	150 30 26	— — —	— 30 —		
Hold Time, Pn to PE	t_H	2 4.5 6	3 3 3	— — —	— 3 —	— — —	3 3 3	— — —	— 3 —	— — —	3 3 3	— — —	— 3 —		
$\overline{CI}$ to CP	t_H	2 4.5 6	5 5 5	— — —	— 5 —	— — —	5 5 5	— — —	— 5 —	— — —	5 5 5	— — —	— 5 —		
U/D to CP	t_H	2 4.5 6	0 0 0	— — —	— 0 —	— — —	0 0 0	— — —	— 0 —	— — —	0 0 0	— — —	— 0 —		
Removal Time: MR to CP	t_{REM}	2 4.5 6	80 16 14	— — —	— 16 —	— — —	100 20 17	— — —	— 20 —	— — —	120 24 20	— — —	— 24 —		
Maximum Frequency CP	f_{MAX}	2 4.5 6	6 30 35	— — —	— 30 —	— — —	5 24 28	— — —	— 24 —	— — —	4 20 24	— — —	— 20 —		MHz

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

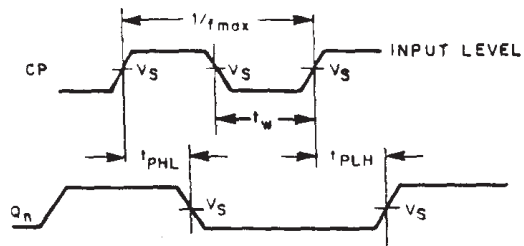
SWITCHING CHARACTERISTICS ($C_L=50$ pF, Input $t_r, t_f=6$ ns)

CHARACTERISTIC		VCC (V)	LIMITS												UNITS
			25° C				-40° C to +85° C				-55° C to +125° C				
			HC		HCT		74HC		74HCT		54HC		54HCT		
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Propagation Delay: CP to Qn	t _{PLH}	2	—	220	—	—	—	275	—	—	—	330	—	—	ns
	t _{PHL}	4.5	—	44	—	50	—	55	—	63	—	66	—	75	
		6	—	37	—	—	—	47	—	—	—	56	—	—	
CP to $\overline{CO}$	t _{PLH}	2	—	260	—	—	—	325	—	—	—	390	—	—	
	t _{PHL}	4.5	—	52	—	58	—	65	—	73	—	78	—	87	
		6	—	44	—	—	—	55	—	—	—	66	—	—	
PE to Qn	t _{PLH}	2	—	250	—	—	—	315	—	—	—	375	—	—	
	t _{PHL}	4.5	—	50	—	53	—	63	—	66	—	75	—	80	
		6	—	43	—	—	—	54	—	—	—	64	—	—	
PE to $\overline{CO}$	t _{PLH}	2	—	300	—	—	—	375	—	—	—	450	—	—	
	t _{PHL}	4.5	—	60	—	68	—	75	—	85	—	90	—	102	
		6	—	51	—	—	—	64	—	—	—	76	—	—	
MR to Qn	t _{PHL}	2	—	210	—	—	—	265	—	—	—	315	—	—	
		4.5	—	42	—	42	—	53	—	53	—	63	—	63	
		6	—	36	—	—	—	45	—	—	—	54	—	—	
MR to $\overline{CO}$	t _{PLH}	2	—	235	—	—	—	295	—	—	—	355	—	—	
		4.5	—	47	—	47	—	59	—	59	—	71	—	71	
		6	—	40	—	—	—	50	—	—	—	60	—	—	
$\overline{CI}$ to $\overline{CO}$	t _{PLH}	2	—	125	—	—	—	155	—	—	—	190	—	—	
	t _{PHL}	4.5	—	25	—	31	—	31	—	39	—	38	—	47	
		6	—	21	—	—	—	26	—	—	—	32	—	—	
Transition Time: Qn, $\overline{CO}$	t _{THL}	2	—	75	—	—	—	95	—	—	—	110	—	—	
	t _{TLH}	4.5	—	15	—	15	—	19	—	19	—	22	—	22	
		6	—	13	—	—	—	16	—	—	—	19	—	—	
Input Capacitance	C _i		—	10	—	10	—	10	—	10	—	10	—	10	pF

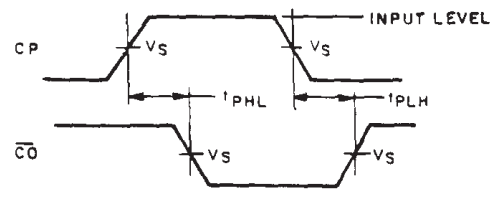
ns

pF

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516

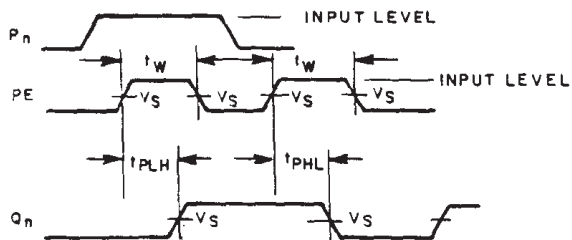


(a) Clock to output delays and clock pulse width.

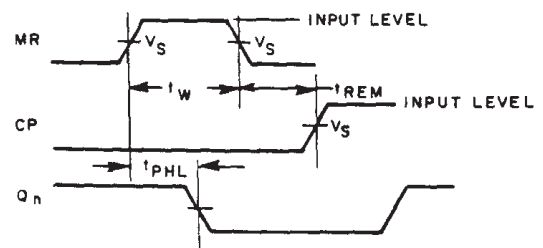


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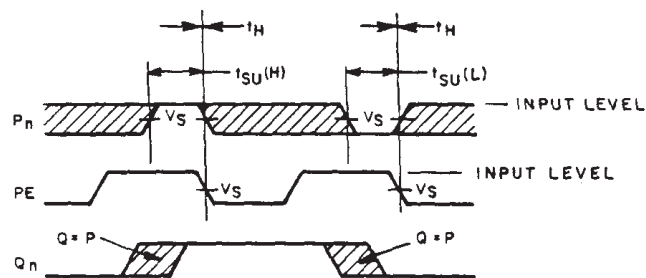
(b) Clock to carry out delays.



(c) Preset Enable pulse width and Preset Enable to output delays.



(d) Master reset pulse width, master reset to output delay and master reset to clock removal time.



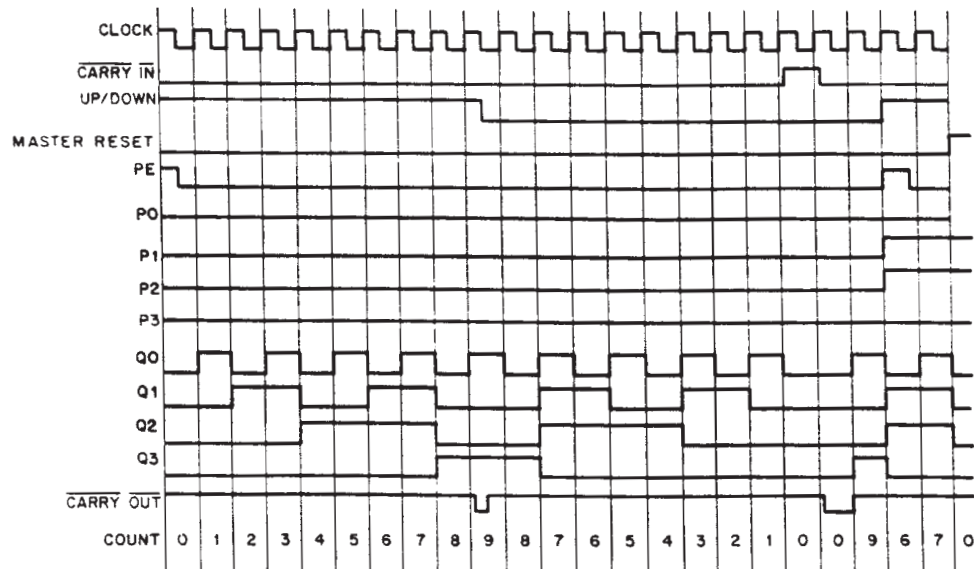
92CM-40081

(e) Setup and hold times data to Preset Enable (PE).

	54/74HC	54/74HCT
Input Level	V_{CC}	3 V
Switching Voltage, V_S	50% V_{CC}	1.3 V

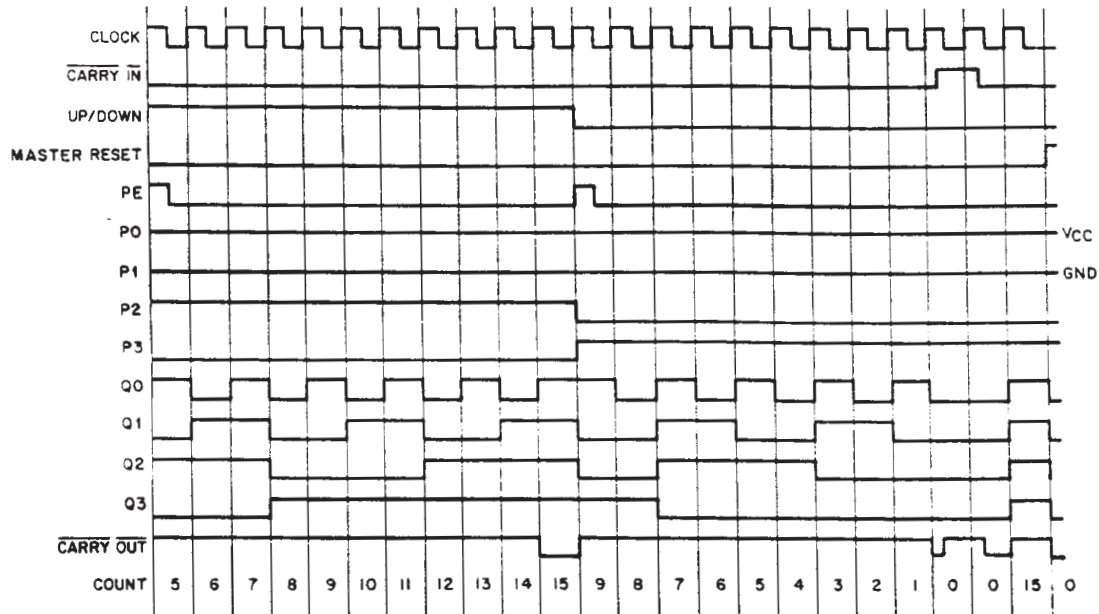
Fig. 4 - AC waveforms.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516



92CM-40108

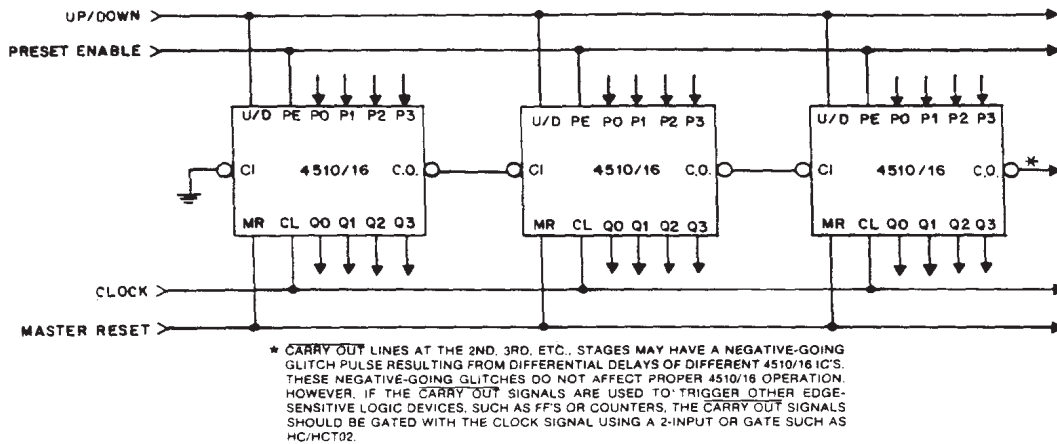
Fig. 5 - Timing diagram for CD54/74HC/HCT4510.



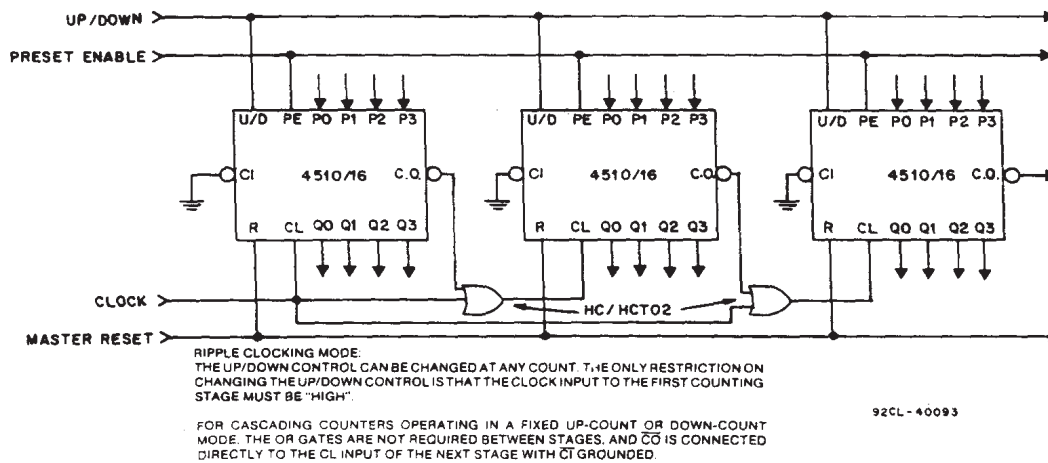
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Fig. 6 - Timing diagram for CD54/74HC/HCT4516.

CD54/74HC4510, CD54/74HCT4510 CD54/74HC4516, CD54/74HCT4516



(a) Parallel clocking.



(b) Ripple clocking.

Fig. 7 - Cascading counter packages.

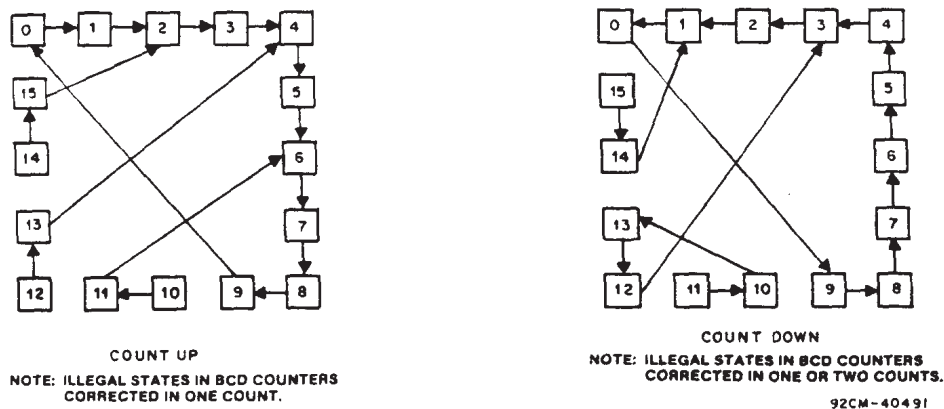


Fig. 8 - HC/HCT4510 State Diagrams.

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